

LOCTITE ABLESTIK CDF 200

April 2014

PRODUCT DESCRIPTION

LOCTITE ABLESTIK CDF 200 provides the following product characteristics:

Technology	Hybrid chemistry
Appearance	Silver film
Cure	Heat cure
Product Benefits	<ul style="list-style-type: none"> • High MSL reliability • Controlled fillet size • No resin bleed-out • Consistent bondline thickness • Pre-cut wafer lamination equipment compatible • Recommended for thin wafer handling applications • Low in-package thermal and electrical resistance
Film Thickness	15µm and 30µm
Application	Die attach
Typical Package Application	QFN, SOIC, SO

LOCTITE ABLESTIK CDF 200 highly filled, conductive die attach adhesive is designed to provide high thermal and electrical conductivity in the attachment of integrated circuits and components onto metallic leadframes. It can be used in a variety of die sizes ranging from 0.2mm x 0.2mm to 5mm x 5mm. This adhesive exhibits strong adhesion to various wafer metallizations and leadframe finishes.

TYPICAL PROPERTIES OF UNCURED MATERIAL

Filler Content, %	84.5
Work Life @ 25°C, days	90
Shelf Life @ 0 to 5°C, days	365

TYPICAL CURING PERFORMANCE

Cure Schedule

30 minute ramp from 25°C to 200°C, hold 60 minutes at 200°C

Alternate Cure Schedule

30 minute ramp from 25°C to 175°C, hold 60 minutes at 175°C

The above cure profiles are guideline recommendations. Cure conditions (time and temperature) may vary based on customers' experience and their application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

TYPICAL PROPERTIES OF CURED MATERIAL

Physical Properties

Coefficient of Thermal Expansion :	
Below Tg, ppm/°C	48
Above Tg, ppm/°C	119
Glass Transition Temperature, °C	15

Tensile Modulus @ 25 °C	N/mm ²	5,400
	(psi)	(783,200)

Thermal Properties

Thermal Conductivity (Bulk), ASTM E1461, W/(m-K)	2.3
Thermal Resistance (Rth), In-package:	
Thermal Die on QFN, K/W	1.5

Electrical Properties

Volume Resistivity (Bulk), ohm-cm	0.0007
Electrical Resistance, RDSon Testing:	
MOSFET Die on TO-220, ohms	0.077

Refer to Data Package for In-Package Thermal and Electrical Performance testing details.

TYPICAL PERFORMANCE OF CURED MATERIAL

Shear Strength

Hot Die Shear Strength @ 260°C:	
2 X 2 mm (80 x 80 mil) die on PPF LF, kg/mm ²	1.3

GENERAL INFORMATION

For safe handling information on this product, consult the Material Safety Data Sheet, (MSDS).

DIRECTIONS FOR USE

1. Refrigerator storage is recommended.
2. Care must be exercised to avoid entrapment of contaminants.
3. Avoid overheating.
4. Alternate thicknesses may be used depending on the application requirements.
5. Recommended silicon wafer backside lamination temperature is 65°C or higher.
6. Please contact your Henkel Technical Service representative for details regarding ideal lamination temperatures for your specific wafer and dicing tape recommendation.

Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.

Storage

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

Optimal Storage : 0 to 5 °C

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative

Conversions $(^{\circ}\text{C} \times 1.8) + 32 = ^{\circ}\text{F}$ $\text{kV/mm} \times 25.4 = \text{V/mil}$ $\text{mm} / 25.4 = \text{inches}$ $\text{N} \times 0.225 = \text{lb}$ $\text{N/mm} \times 5.71 = \text{lb/in}$ $\text{N/mm}^2 \times 145 = \text{psi}$ $\text{MPa} = \text{N/mm}^2$ $\text{MPa} \times 145 = \text{psi}$ $\text{N}\cdot\text{m} \times 8.851 = \text{lb}\cdot\text{in}$ $\text{N}\cdot\text{m} \times 0.738 = \text{lb}\cdot\text{ft}$ $\text{N}\cdot\text{mm} \times 0.142 = \text{oz}\cdot\text{in}$ $\text{mPa}\cdot\text{s} = \text{cP}$

Reference 0.1

Disclaimer**Note:**

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